# 3.3V Surface Mount 3.2mm x 5.0mm Oscillators V7123 & V7133 Series



VCXO

The Connor-Winfield, RoHS compliant, V7123 and V7133 are hermetically sealed, Surface Mount, 3.3V Voltage Controlled Crystal Oscillators (VCXO) with Tri-State Enable/Disable function on pad 6. The V7123 and V7133 are designed for phased lock loop applications requiring low jitter and tight stability.

Features:

RoHS Compliant
3.3V Operation
Small Surface Mount Package:
5.0mm x 3.2mm x 1.2mm
Overall Frequency Tolerance:

V7123: ±50ppm V7133: ±100ppm Low Jitter <1pS RMS Temperature Range -10° to 70°C Enable / Disable Pad 6 Tape and Reel Packaging

		la	ape and Reel F	ackaging		
Absolute Maximum Ratings						
Parameter	Minimum	Nominal	Maximum	Units	Notes	
Storage Temperature	-55	-	125	°C		
Supply Voltage (Vcc)	-0.5	-	7.0	Vdc		
Control Voltage (Vc)	-0.5	-	Vcc	Vdc		
Operating Specifications						
Parameter	Minimum	Nominal	Maximum	Units	Notes	
Frequency Range (Fo)	2.0	-	52	MHz		
Frequency Tolerance Model V7123 Model V7133	-50 -100	-	50 100	ppm	1	
Operating Temperature Range	-10	-	70	°C		
Supply Voltage (Vcc)	3.135	3.3	3.465	Vdc		
Supply Current (Icc) 1.0 to 29.999 MHz 30 to 52 MHz	-	- -	15 25	mA		
Jitter: (BW=12kHz to 20 MHz) (BW=10Hz to 20 MHz)	- -	- -	1 5	ps RMS		
Input Characteristics						
Parameter	Minimum	Nominal	Maximum	Units	Notes	
Control Voltage Range (Vc)	0.15	1.65	3.15	Vdc		
Frequency Pullability @ 25°C	±100	-	-	ppm		
Monotonic Linearity	-10	-	10	%		
Input Impedance	-	50K	-	Ohm		
Modulation Bandwidth (3dB)	10	-	-	KHz		
Enable Input Voltage - High (Vih) Disable Input Voltage - Low (Vil)	2.7	-	0.3	Vdc	2	
LVCMOS Output Characteristics						
Parameter	Minimum	Nominal	Maximum	Units	Notes	
Load	-	-	15	pf		
Voltage High (Voh) Low (Vol)	2.7 -	-	0.33	Vdc		
Current High (loh) Low (lol)	-1 -	-	- 4	mA		
Duty Cycle at 50% of Vcc	40	50	60	%		
Rise / Fall Time 20% to 80%	-	-	5	nS		
Start-up Time	-	-	10	mS		



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# Notes:

- 1. Referenced to (Fo) measured with control voltage @ 2.5Vdc. Inclusive of frequency vs. temperature stability, supply voltageload change, shock and vibration, 15 years aging.
- $2. \ \, \text{The Output is enabled with no connection on the enable pin. Output is at high impedance when disabled}.$



### **Package Characteristics**

Package Hermetically sealed, ceramic leadless package.

### Environmental Characteristics

The specimen shall meet electrical characteristics after tested 5 cycles of -55°C / 30 minutes and +125°C / 30 minutes Temperature Cycle

Hermetical No bubbles appear in Flourinert (FC-43) at 125°C ±5°C for 5 minutes

Marking will withstand immersion in Isopropyl Alcohol or Trichloroethylene Solvent Resistance

### Soldering

260°C max x 10 sec max x 2 times max or 230°C max x 180 sec max x 1 time General Conditions

20 to 100 sec up to 215°C, 50 sec at 215°C, then down to room temperature per 1 to 5°C / sec Typical Operation Data (Vapor phase reflow)

# **Mechanical Characteristics**

The specimen shall meet electrical characteristics after tested 3 times, Free Drop Free Drop testing on the hard wooden board from a height of 75 cm.

The specimen shall meet electrical characteristics after tested by the following conditions: 10-55Hz 1.5mm Amplitude, 55-2000 Hz 20 G's, 2 hours for each plane Vibration

After applied Thermal Shock of 245°C max x 10 sec max x 2 times, or 215°C max x 180 sec max, Thermal Shock

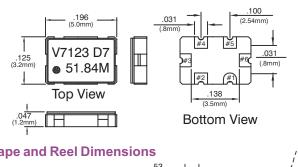
the specimen shall meet electrical characteristics

Solderability

(EIAJ-RCX-0102/101 Condition 1a) Flux: MIL-F-14256 (WW Rosin=25%, Isopropyl Alcohol = 75%) Solder: QQ-S-571 (Sn = 63%, Pb = 37%) Solder bath temperature: 235°C  $\pm$ 5°C

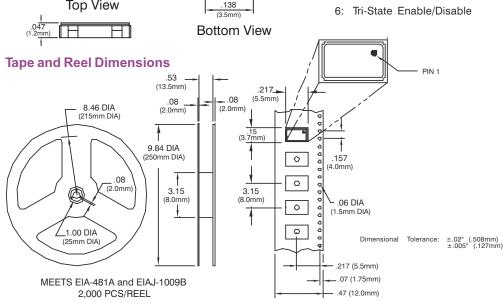
Depth of immersion: Up to electrical terminal Immersing time: Within 2 sec ±0.5 sec into solder bath

# After performing the above procedures, a newly soldered coverage shall be greater than 90%

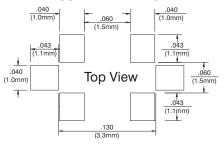


### Pin Function

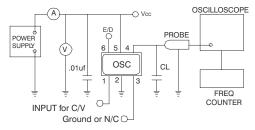
- Control Voltage
- Ground
- 3: Ground or No Connection
- 4: Output
- 5: Vcc



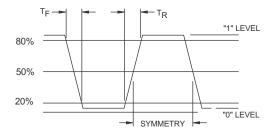
# **Suggested Pad Layout**



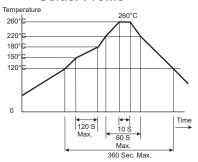
### **Test Circuit**



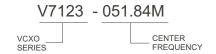
## Output Waveform



### **Solder Profile**



# **Ordering Information**



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